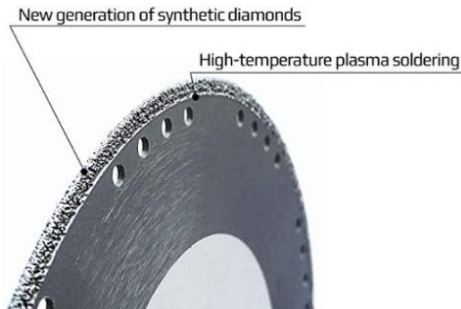


Professional Angle Grinder Cutting Wheel



Art.No.	D(mm)	D (inch)	Bore (mm)	Diamond Thickness	RPM Max
PJPDM105	105	4"	20	1.4	15500
PJPDM115	115	4-1/2"	22.23	1.4	13300
PJPDM125	125	5"	22.23	1.4	12500
PJPDM150	150	6 "	22.23	1.6	10200
PJPDM180	180	7"	22.23	2.2	8500
PJPDM230	230	9"	22.23	2.4	6500
PJPDM300	300	12"	25.4	2.8	5500
PJPDM350	350	14"	25.4	3	5000
PJPDM400	400	16"	25.4	3	4300

--METAL CUTTING

- ※ Recommended for multiple types of metal including steel, sheet metal, stainless steel, rebar, cast iron, aluminum and non-ferrous metals.
- ※ Lifetime is 60-100 times longer than the usual grinding because of high-temperature plasma soldering technology and using new generation of diamond grit. 3000 cuts is guaranteed.
- ※ Environmental friendly: less sparks, no dust, no smell.



Art.No.	D(mm)	D (inch)	Bore (mm)	Diamond Thickness	RPM Max
PJPDL105	105	4"	20	1.4	15500
PJPDL115	115	4-1/2"	22.23	1.4	13300
PJPDL125	125	5"	22.23	1.4	12500
PJPDL150	150	6"	22.23	1.6	10200
PJPDL180	180	7"	22.23	2.2	8500
PJPDL230	230	9"	22.23	2.4	6500
PJPDL300	300	12"	25.4	2.8	5500
PJPDL350	350	14"	25.4	3	5000
PJPDL400	400	16"	25.4	3	4300

--METAL CUTTING

- ※ Recommended for multiple types of metal including steel, sheet metal, stainless steel, rebar, cast iron, aluminum and non-ferrous metals.
- ※ Lifetime is 60-100 times longer than the usual grinding because of high-temperature plasma soldering technology and using new generation of diamond grit.3000 cuts is guaranteed.
- ※ Environmental friendly:less sparks, no dust, no smell.
- ※ Better for glass fibre material.



Art.No.	D(mm)	D (inch)	Bore (mm)	Diamond Thickness	RPM Max
PJPDU115	115	4-1/2"	22.23	2.2	13300
PJPDU125	125	5"	22.23	2.2	12500
PJPDU150	150	6"	22.23	2.4	10200
PJPDU180	180	7"	22.23	2.8	8500
PJPDU230	230	9"	22.23	3	6500
PJPDU300	300	12"	25.4	3.2	5500
PJPDU350	350	14"	25.4	3.5	5000
PJPDU400	400	16"	25.4	3.5	4300

--UNIVERSAL CUTTING

- ※ Recommended for cutting wood, tubular metals, non-ferrous metals, masonry products, tiles and PVC.
- ※ Advantage:
 - Broader usage.
 - Better chip-removal performance
 - High efficiency.